



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RECEIVED  
JAN 07 2004  
TC 1700

In re application of:

CHAD A. COBBLEY  
TONGBI JIANG  
ED A. SCHROCK

Serial No. 08/916,629

Art Unit: 1733

Filing Date: AUGUST 22, 1997

Examiner: Aftergut, J.H.

For: SEMICONDUCTOR DIE ATTACHMENT  
METHOD AND APPARATUS

Attorney Docket No. 97-0098

---

**AMENDMENT**

**December 24, 2003**

Mail Stop Non Fee Amendment  
Commissioner For Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This Amendment is in response to the Office Action dated 09/24/2003 having a statutory period for response set to expire on 12/24/2003. Please amend the case as follows.